

Title (en)

Capacitor element and method of encapsulating a capacitor base body

Title (de)

Kondensatorelement und Verfahren zur Einkapselung eines Kondensatorgrundkörpers

Title (fr)

Élément de condensateur et procédé d'intégration d'un corps de base de condensateur

Publication

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Application

EP 10162724 A 20100512

Priority

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Abstract (en)

[origin: EP2387051A1] A capacitor element (1) is provided, comprising a capacitor base body (2) and an encapsulation (3) of the base body (2). The encapsulation (3) is injection-molded directly onto the base body (2). Furthermore, a method for encapsulating a capacitor base body (2) is provided.

IPC 8 full level

H01G 2/10 (2006.01); **H01G 4/224** (2006.01)

CPC (source: EP)

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Cited by

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